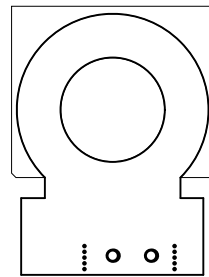
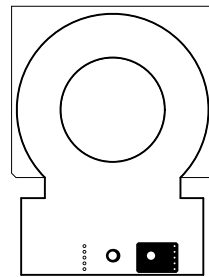


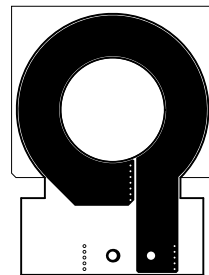
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pri_4Ts	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #:		
PLOT NAME = Top Overlay	GENERATED : 4/29/2016 11:06:12 PM	TEXAS INSTRUMENTS	



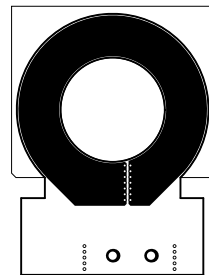
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #:		
PLOT NAME = Top Solder Mask	GENERATED : 4/29/2016 11:06:13 PM	TEXAS INSTRUMENTS	



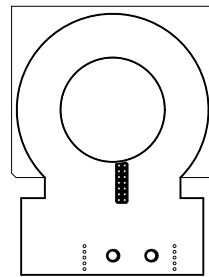
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #:		
PLOT NAME = Top Layer	GENERATED : 4/29/2016 11:06:13 PM	TEXAS INSTRUMENTS	



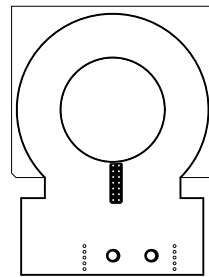
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 1	GENERATED : 4/29/2016 11:06:14 PM		TEXAS INSTRUMENTS



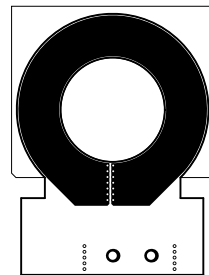
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 2	GENERATED : 4/29/2016 11:06:14 PM		TEXAS INSTRUMENTS



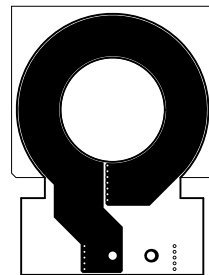
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 3	GENERATED : 4/29/2016 11:06:15 PM		TEXAS INSTRUMENTS



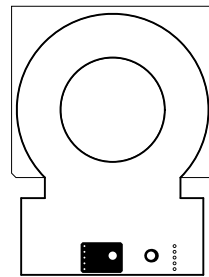
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_i_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 4	GENERATED : 4/29/2016 11:06:15 PM	TEXAS INSTRUMENTS	



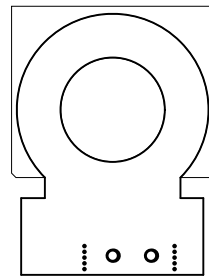
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 5	GENERATED : 4/29/2016 11:06:16 PM		TEXAS INSTRUMENTS



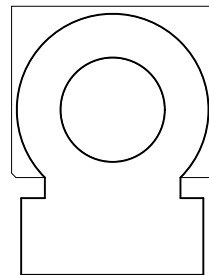
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #:		
PLOT NAME = Signal Layer 6	GENERATED : 4/29/2016 11:06:17 PM		TEXAS INSTRUMENTS



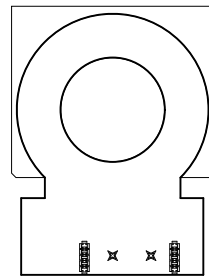
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #:		
PLOT NAME = Bottom Layer	GENERATED : 4/29/2016 11:06:17 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #:		
PLOT NAME = Bottom Solder Mask	GENERATED : 4/29/2016 11:06:18 PM	TEXAS INSTRUMENTS	

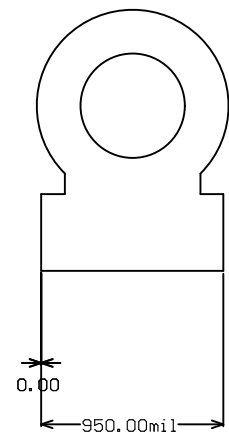
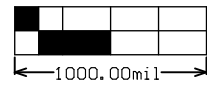


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #:		
PLOT NAME = Bottom Overlay	GENERATED : 4/29/2016 11:06:18 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊕	10	10.00mil (0.254mm)	PTH	Round
✕	2	43.00mil (1.092mm)	PTH	Round
	12 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4TR	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #:		
PLOT NAME = Drill Drawing	GENERATED : 4/29/2016	11:06:19 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP12047_pr_4	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #:		
PLOT NAME = Board Dimensions	GENERATED : 4/29/2016 11:06:20 PM	TEXAS INSTRUMENTS	

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